TOSHIBA PHOTOCOUPLER

# TLP3009(D4)SERIES

#### ATTACHMENT : SPECIFICATIONS FOR <u>VDE0884</u> OPTION: (D4)

Types

: TLP3009, TLP3010, TLP3011, TLP3012 TLP3031, TLP3032, TLP3033 TLP3051, TLP3052 TLP3061, TLP3062, TLP3063 TLP3061

Note: Use Toshiba standard type number for safety standard application. Ex. TLP3063(D4-LF2)  $\rightarrow$  TLP3063

### **VDE0884 ISOLATION CHARACTERISTICS**

| DESCRIPTION  | SYMBOL            | RATING            | UNIT           |
|--|-------------------|-------------------|----------------|
| Application Classification (DIN VDE0109 12.83, Table 1)<br>for rated mains voltage ≤ 300 V <sub>RMS</sub><br>for rated mains voltage ≤ 600 V <sub>RMS</sub>  |                   | I- IV<br>I- III   | _              |
| Climatic Classification (DIN IEC68 Teil 1 / 09.80)   |                   | 55 / 100 / 21     | —              |
| Pollution Degree (DIN VDE0109 / 12.83)   |                   | 2                 | —              |
| Maximum Operating Insulation Voltage   | VIORM             | 630               | Vpk            |
| Input to output Test Voltage, Method A<br>Vpr=1.2 × V <sub>IORM</sub> , Type and Sample Test<br>tp = 60s, Partial Discharge < 5pC  | Vpr               | 760               | Vpk            |
| Input to output Test Voltage, Method B<br>Vpr = 1.6 × V <sub>IORM</sub> , 100% Production Test<br>tp = 1s, Partial Discharge < 5pC   | Vpr               | 1000              | Vpk            |
| Highest Permissible Overvoltage (Transient Overvoltage, t <sub>pr</sub> = 10s)   | V <sub>TR</sub>   | 6000              | Vpk            |
| Safety Limiting Values (Max. permissible ratings in case of fault, also refer to<br>thermal derating curve<br>Current (Input current I <sub>F</sub> , Psi = 0)<br>Power (Output or Total Power Dissipation)<br>Temperature | lsi<br>Psi<br>Tsi | 400<br>700<br>150 | mA<br>mW<br>°C |
| Insulation Resistance at Tsi, V <sub>IO</sub> = 500V   | Rsi               | ≥10 <sup>9</sup>  | Ω              |

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### INSULATION RELATED SPECIFICATIONS

|  |     | $\square$                           |                              |
|--|-----|-------------------------------------|------------------------------|
|  |     | 7.62 mm pitch standard type         | 10.16 mm pitch<br>(LF2 type) |
| Minimum Creepage Distance*                                   | Cr  | 7.0 mm                              | 8.0 mm                       |
| Minimun Clearance*   | CI  | 7.0 mm                              | 8.0 mm                       |
| Minimum Insulation Thickness                                 | ti  | 0.5 mm                              |                              |
| Comperative Tracking Index<br>(DIN IEC112 / VDE0303, Part 1) | СТІ | 175<br>(VDE0109 / 12.83 Group IIIa) |                              |

\*: in accordance with DIN VDE0109 12.83, Table 2, & 4)

- 1. If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value (e. g. at a standard distance between soldering eye centres of 7.5mm). If this is not permissible, the user shall take suitable measures.
- 2. This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of porotective circuits.

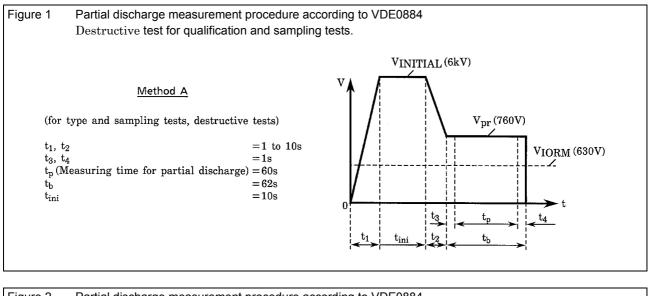
VDE Test sign : Marking on product for VDE0884 :

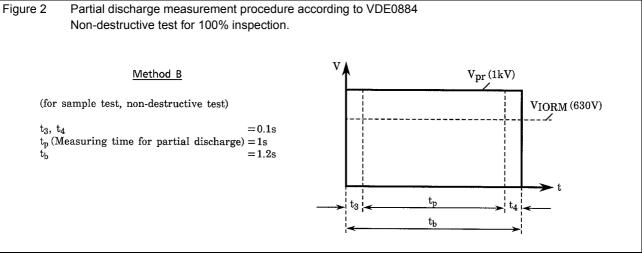


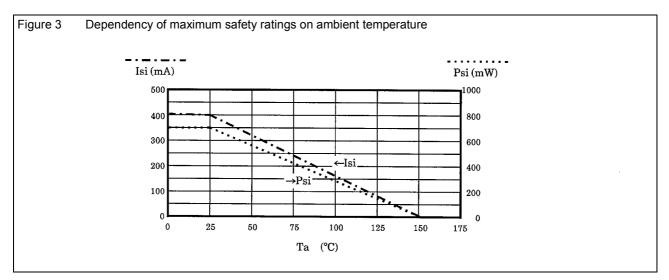
Marking on packing for VDE0884 :



### **TOSHIBA**







### **RESTRICTIONS ON PRODUCT USE**

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  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
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